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#### What is "Embedded - Microcontrollers"?

"Embedded - Microcontrollers" refer to small, integrated circuits designed to perform specific tasks within larger systems. These microcontrollers are essentially compact computers on a single chip, containing a processor core, memory, and programmable input/output peripherals. They are called "embedded" because they are embedded within electronic devices to control various functions, rather than serving as standalone computers. Microcontrollers are crucial in modern electronics, providing the intelligence and control needed for a wide range of applications.

Applications of "<u>Embedded -</u> <u>Microcontrollers</u>"

#### Details

E·XF

Product Status	Obsolete
Core Processor	PIC
Core Size	8-Bit
Speed	4MHz
Connectivity	-
Peripherals	POR, WDT
Number of I/O	12
Program Memory Size	1.5KB (1K x 12)
Program Memory Type	OTP
EEPROM Size	-
RAM Size	25 x 8
Voltage - Supply (Vcc/Vdd)	2.5V ~ 5.5V
Data Converters	-
Oscillator Type	External
Operating Temperature	-40°C ~ 85°C (TA)
Mounting Type	Surface Mount
Package / Case	18-SOIC (0.295", 7.50mm Width)
Supplier Device Package	18-SOIC
Purchase URL	https://www.e-xfl.com/product-detail/microchip-technology/pic16lc56at-04i-so

Email: info@E-XFL.COM

Address: Room A, 16/F, Full Win Commercial Centre, 573 Nathan Road, Mongkok, Hong Kong

# 6.0 MEMORY ORGANIZATION

PIC16C5X memory is organized into program memory and data memory. For devices with more than 512 bytes of program memory, a paging scheme is used. Program memory pages are accessed using one or two STATUS Register bits. For devices with a data memory register file of more than 32 registers, a banking scheme is used. Data memory banks are accessed using the File Selection Register (FSR).

### 6.1 Program Memory Organization

The PIC16C54, PIC16CR54 and PIC16C55 have a 9bit Program Counter (PC) capable of addressing a 512 x 12 program memory space (Figure 6-1). The PIC16C56 and PIC16CR56 have a 10-bit Program Counter (PC) capable of addressing a 1K x 12 program memory space (Figure 6-2). The PIC16CR57, PIC16C58 and PIC16CR58 have an 11-bit Program Counter capable of addressing a 2K x 12 program memory space (Figure 6-3). Accessing a location above the physically implemented address will cause a wraparound.

A NOP at the RESET vector location will cause a restart at location 000h. The RESET vector for the PIC16C54, PIC16CR54 and PIC16C55 is at 1FFh. The RESET vector for the PIC16C56 and PIC16CR56 is at 3FFh. The RESET vector for the PIC16C57, PIC16CR57, PIC16C58, and PIC16CR58 is at 7FFh. See Section 6.5 for additional information using CALL and GOTO instructions.

#### FIGURE 6-1: PIC16C54/CR54/C55 PROGRAM MEMORY MAP AND STACK



#### FIGURE 6-2:

#### PIC16C56/CR56 PROGRAM MEMORY MAP AND STACK



FIGURE 6-3:

PIC16C57/CR57/C58/ CR58 PROGRAM MEMORY MAP AND STACK



# 7.0 I/O PORTS

As with any other register, the I/O Registers can be written and read under program control. However, read instructions (e.g., MOVF PORTB, W) always read the I/O pins independent of the pin's input/output modes. On RESET, all I/O ports are defined as input (inputs are at hi-impedance) since the I/O control registers (TRISA, TRISB, TRISC) are all set.

# 7.1 PORTA

PORTA is a 4-bit I/O Register. Only the low order 4 bits are used (RA<3:0>). Bits 7-4 are unimplemented and read as '0's.

# 7.2 PORTB

PORTB is an 8-bit I/O Register (PORTB<7:0>).

# 7.3 PORTC

PORTC is an 8-bit I/O Register for PIC16C55, PIC16C57 and PIC16CR57.

PORTC is a General Purpose Register for PIC16C54, PIC16CR54, PIC16CR56, PIC16CR56, PIC16CS8 and PIC16CR58.

# 7.4 TRIS Registers

The Output Driver Control Registers are loaded with the contents of the W Register by executing the TRIS f instruction. A '1' from a TRIS Register bit puts the corresponding output driver in a hi-impedance (input) mode. A '0' puts the contents of the output data latch on the selected pins, enabling the output buffer.

Note:	A read of the ports reads the pins, not the
	output data latches. That is, if an output
	driver on a pin is enabled and driven high,
	but the external system is holding it low, a
	read of the port will indicate that the pin is
	low.

The TRIS Registers are "write-only" and are set (output drivers disabled) upon RESET.

TABLE 7-1:	SUMMARY O	F PORT	REGISTERS
			LOIOI LIVO

#### Value on Value on Bit 4 Bit 3 Bit 1 Bit 0 MCLR and Address Name Bit 7 Bit 6 Bit 5 Bit 2 Power-On Reset WDT Reset TRIS N/A I/O Control Registers (TRISA, TRISB, TRISC) 1111 1111 1111 1111 05h PORTA RA3 RA2 RA1 RA0 \_ \_ \_ \_ xxxx \_ \_ \_ \_ uuuu PORTB 06h RB7 RB6 RB5 RB4 RB3 RB2 RB1 RB0 XXXX XXXX uuuu uuuu 07h PORTC RC7 RC6 RC5 RC4 RC3 RC2 RC1 RC0 XXXX XXXX uuuu uuuu

Legend: x = unknown, u = unchanged, - = unimplemented, read as '0', Shaded cells = unimplemented, read as '0'

### 7.5 I/O Interfacing

The equivalent circuit for an I/O port pin is shown in Figure 7-1. All ports may be used for both input and output operation. For input operations these ports are non-latching. Any input must be present until read by an input instruction (e.g., MOVF PORTB, W). The outputs are latched and remain unchanged until the output latch is rewritten. To use a port pin as output, the corresponding direction control bit (in TRISA, TRISB, TRISC) must be cleared (= 0). For use as an input, the corresponding TRIS bit must be set. Any I/O pin can be programmed individually as input or output.

#### FIGURE 7-1: EQUIVALENT CIRCUIT FOR A SINGLE I/O PIN



#### 8.2 Prescaler

An 8-bit counter is available as a prescaler for the Timer0 module, or as a postscaler for the Watchdog Timer (WDT), respectively (Section 9.2.1). For simplicity, this counter is being referred to as "prescaler" throughout this data sheet. Note that the prescaler may be used by either the Timer0 module or the WDT, but not both. Thus, a prescaler assignment for the Timer0 module means that there is no prescaler for the WDT, and vice-versa.

The PSA and PS<2:0> bits (OPTION<3:0>) determine prescaler assignment and prescale ratio.

When assigned to the Timer0 module, all instructions writing to the TMR0 register (e.g., CLRF 1, MOVWF 1, BSF 1, x, etc.) will clear the prescaler. When assigned to WDT, a CLRWDT instruction will clear the prescaler along with the WDT. The prescaler is neither readable nor writable. On a RESET, the prescaler contains all '0's.

#### 8.2.1 SWITCHING PRESCALER ASSIGNMENT

The prescaler assignment is fully under software control (i.e., it can be changed "on the fly" during program execution). To avoid an unintended device RESET, the following instruction sequence (Example 8-1) must be executed when changing the prescaler assignment from Timer0 to the WDT.

#### EXAMPLE 8-1: CHANGING PRESCALER (TIMER0→WDT)

CLRWDT	;Clear WDT
CLRF TMR0	;Clear TMR0 & Prescaler
MOVLW B'00xx1111'	;Last 3 instructions in
	this example
OPTION	;are required only if
	;desired
CLRWDT	;PS<2:0> are 000 or
	;001
MOVLW B'00xx1xxx'	;Set Prescaler to
OPTION	;desired WDT rate

To change prescaler from the WDT to the Timer0 module, use the sequence shown in Example 8-2. This sequence must be used even if the WDT is disabled. A CLRWDT instruction should be executed before switching the prescaler.

# EXAMPLE 8-2: CHANGING PRESCALER (WDT $\rightarrow$ TIMER0)

CLRWDT		;Clear WDT and
		;prescaler
MOVLW	B'xxxx0xxx'	;Select TMR0, new
		;prescale value and
		;clock source

OPTION

GOTO	Uncondi	tional Br	anch
Syntax:	[ label ]	GOTO	k
Operands:	$0 \le k \le 5^{-1}$	11	
Operation:	$k \rightarrow PC < STATUS$	8:0>; <6:5> →	PC<10:9>
Status Affected:	None		
Encoding:	101k	kkkk	kkkk
Description:	GOTO is a The 9-bit loaded in upper bits STATUS- cycle inst	an uncone immedia to PC bit s of PC a <6:5>. GC truction.	ditional branch. te value is s <8:0>. The re loaded from DTO is a two-
Words:	1		
Cycles:	2		
Example:	GOTO TH	IERE	
After Instructi PC =	on address	G (THER	E)

INCF	Increment f
Syntax:	[label] INCF f,d
Operands:	$\begin{array}{l} 0 \leq f \leq 31 \\ d  \in  [0,1] \end{array}$
Operation:	(f) + 1 $\rightarrow$ (dest)
Status Affected:	Z
Encoding:	0010 10df ffff
Description:	The contents of register 'f' are incremented. If 'd' is 0 the result is placed in the W register. If 'd' is 1 the result is placed back in register 'f'.
Words:	1
Cycles:	1
Example:	INCF CNT, 1
Before Instru CNT Z After Instructi CNT Z	ction = 0xFF = 0 ion = 0x00 = 1

INCFSZ	Increment f, Skip if 0						
Syntax:	[label] INCFSZ f,d						
Operands:	$\begin{array}{l} 0\leq f\leq 31\\ d\in [0,1] \end{array}$						
Operation:	(f) + 1 $\rightarrow$ (dest), skip if result = 0						
Status Affected:	None						
Encoding:	0011 11df ffff						
Description:	The contents of register 'f' are incremented. If 'd' is 0 the result is placed in the W register. If 'd' is 1 the result is placed back in register 'f'. If the result is 0, then the next instruction, which is already fetched, is discarded and a NOP is executed instead making it a two- cycle instruction.						
Words:	1						
Cycles:	1(2)						
Example:	HERE INCFSZ CNT, 1 GOTO LOOP						
	CONTINUE • •						
Before Instru	iction						
PC	= address (HERE)						
After Instruct	ion						
CNT	= CNT + 1;						
if CNT	= 0,						
PC	= address (CONTINUE);						
if CNT	≠ 0, 						
PC	= address (HERE +1)						

# 11.0 DEVELOPMENT SUPPORT

The PIC<sup>®</sup> microcontrollers are supported with a full range of hardware and software development tools:

- Integrated Development Environment
  - MPLAB<sup>®</sup> IDE Software
- Assemblers/Compilers/Linkers
  - MPASM<sup>™</sup> Assembler
  - MPLAB C17 and MPLAB C18 C Compilers
  - MPLINK™ Object Linker/
  - MPLIB<sup>™</sup> Object Librarian
- Simulators
  - MPLAB SIM Software Simulator
- Emulators
  - MPLAB ICE 2000 In-Circuit Emulator
  - ICEPIC<sup>™</sup> In-Circuit Emulator
- In-Circuit Debugger
- MPLAB ICD
- Device Programmers
  - PRO MATE<sup>®</sup> II Universal Device Programmer
- PICSTART<sup>®</sup> Plus Entry-Level Development Programmer
- Low Cost Demonstration Boards
  - PICDEM<sup>™</sup>1 Demonstration Board
  - PICDEM 2 Demonstration Board
  - PICDEM 3 Demonstration Board
  - PICDEM 17 Demonstration Board
  - KEELOQ<sup>®</sup> Demonstration Board

### 11.1 MPLAB Integrated Development Environment Software

The MPLAB IDE software brings an ease of software development previously unseen in the 8-bit microcontroller market. The MPLAB IDE is a Windows<sup>®</sup>-based application that contains:

- An interface to debugging tools
  - simulator
  - programmer (sold separately)
  - emulator (sold separately)
  - in-circuit debugger (sold separately)
- A full-featured editor
- A project manager
- Customizable toolbar and key mapping
- A status bar
- On-line help

The MPLAB IDE allows you to:

- Edit your source files (either assembly or 'C')
- One touch assemble (or compile) and download to PIC MCU emulator and simulator tools (automatically updates all project information)
- Debug using:
  - source files
  - absolute listing file
  - machine code

The ability to use MPLAB IDE with multiple debugging tools allows users to easily switch from the cost-effective simulator to a full-featured emulator with minimal retraining.

# 11.2 MPASM Assembler

The MPASM assembler is a full-featured universal macro assembler for all PIC MCUs.

The MPASM assembler has a command line interface and a Windows shell. It can be used as a stand-alone application on a Windows 3.x or greater system, or it can be used through MPLAB IDE. The MPASM assembler generates relocatable object files for the MPLINK object linker, Intel<sup>®</sup> standard HEX files, MAP files to detail memory usage and symbol reference, an absolute LST file that contains source lines and generated machine code, and a COD file for debugging.

The MPASM assembler features include:

- Integration into MPLAB IDE projects.
- User-defined macros to streamline assembly code.
- Conditional assembly for multi-purpose source files.
- Directives that allow complete control over the assembly process.

# 11.3 MPLAB C17 and MPLAB C18 C Compilers

The MPLAB C17 and MPLAB C18 Code Development Systems are complete ANSI 'C' compilers for Microchip's PIC17CXXX and PIC18CXXX family of microcontrollers, respectively. These compilers provide powerful integration capabilities and ease of use not found with other compilers.

For easier source level debugging, the compilers provide symbol information that is compatible with the MPLAB IDE memory display.

# TABLE 11-1: DEVELOPMENT TOOLS FROM MICROCHIP

	PIC12CXXX	PIC14000	PIC16C5X	PIC16C6X	PIC16CXXX	PIC16F62X	X7D81DI9	XX7O91OIG	78291219	PIC16F8XX	PIC16C9XX	PIC17C4X	XXTOTIOI9	PIC18CXX2	PIC18FXXX	63CXX 52CXX/ 54CXX/	хххсэн	мсвеххх	MCP2510
MPLAB <sup>®</sup> Integrated Development Environment	>	>	>	>	>	>	>	>	>	>	>	>	>	>	>				
MPLAB® C17 C Compiler												>	>						
MPLAB® C18 C Compiler														~	>				
MPASM <sup>TM</sup> Assembler/ MPLINK <sup>TM</sup> Object Linker	>	>	>	>	^	>	>	>	>	>	>	>	>	>	>	>	>		
MPLAB® ICE In-Circuit Emulator	<	>	>	~	~	×*`	~	>	>	>	>	>	>	~	>				
ICEPIC <sup>TM</sup> In-Circuit Emulator	>		>	>	>		>	>	>		>								
et MPLAB® ICD In-Circuit Debugger Debugger				*			*			>					>				
ଏ PICSTART® Plus Entry Level ଅପେତା Programmer	<	>	>	>	>	**`	>	>	>	>	>	>	>	>	>				
PRO MATE® II Do Universal Device Programmer D	>	>	>	>	>	** ⁄	>	>	>	>	>	>	>	>	>	>	>		
PICDEM <sup>TM</sup> 1 Demonstration Board			>		>		<b>*</b> +		>			>							
PICDEM <sup>TM</sup> 2 Demonstration Board				∕+			<↓ ↓							>	>				
PICDEM <sup>TM</sup> 3 Demonstration Board											>								
면 PICDEM <sup>TM</sup> 14A Demonstration Board		>																	
☐ PICDEM <sup>™</sup> 17 Demonstration B Board													>						
KEELoq® Evaluation Kit																	>		
KEELoa® Transponder Kit																	>		
e microlD™ Programmer's Kit																		>	
₫ 125 kHz microID™ Developer's Kit																		>	
125 kHz Anticollision microlD <sup>TM</sup> Developer's Kit																		~	
13.56 MHz Anticollision microlD <sup>TM</sup> Developer's Kit																		~	
MCP2510 CAN Developer's Kit																			>
* Contact the Microchip Technology In ** Contact Microchip Technology Inc. ft <sup>†</sup> Development tool is available on sel	nc. web s or avails lect devi	site at w ability da ices.	ww.micr tte.	ochip.cc	om for inf	ormation	on how 1	to use the	9 MPLAB	® ICD In	Circuit I	Debugg	er (DV16	4001) w	ith PIC16	SC62, 63,	64, 65, 7	2, 73, 74,	76, 77.

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# 12.6 Timing Parameter Symbology and Load Conditions

The timing parameter symbols have been created with one of the following formats:

1. TppS2ppS

2. Tp	2. TppS							
Т								
F	Frequency	T Time						
Lowe	ercase letters (pp) and their meanings:							
рр								
2	to	mc MCLR						
ck	CLKOUT	osc oscillator						
су	cycle time	os OSC1						
drt	device reset timer	t0 T0CKI						
io	I/O port	wdt watchdog timer						
Uppe	ercase letters and their meanings:							
S								
F	Fall	P Period						
Н	High	R Rise						
Ι	Invalid (Hi-impedance)	V Valid						
L	Low	Z Hi-impedance						

### FIGURE 12-1: LOAD CONDITIONS FOR DEVICE TIMING SPECIFICATIONS - PIC16C54/55/56/57





#### FIGURE 12-4: RESET, WATCHDOG TIMER, AND DEVICE RESET TIMER TIMING -PIC16C54/55/56/57

#### TABLE 12-3: RESET, WATCHDOG TIMER, AND DEVICE RESET TIMER - PIC16C54/55/56/57

AC Chara	cteristics	Standard Operating Conditions (uOperating Temperature $0^{\circ}C \leq$ $-40^{\circ}C \leq$ $-40^{\circ}C \leq$	I <b>NIESS (</b> TA ≤ +7 TA ≤ +8 TA ≤ +1	otherwi 0°C for 5°C for 25°C for	se spec commei industria r extend	<b>tified)</b> rcial al led	
Param No.	Symbol	Characteristic	Min	Тур†	Max	Units	Conditions
30	TmcL	MCLR Pulse Width (low)	100*	—	_	ns	VDD = 5.0V
31	Twdt	Watchdog Timer Time-out Period (No Prescaler)	9.0*	18*	30*	ms	VDD = 5.0V (Comm)
32	Tdrt	Device Reset Timer Period	9.0*	18*	30*	ms	VDD = 5.0V (Comm)
34	Tioz	I/O Hi-impedance from MCLR Low		_	100*	ns	

\* These parameters are characterized but not tested.

† Data in the Typical ("Typ") column is at 5.0V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.



#### FIGURE 14-5: TYPICAL IPD vs. VDD, WATCHDOG DISABLED



#### 15.3 DC Characteristics: PIC16LV54A-02 (Commercial) PIC16LV54A-02I (Industrial)

PIC16L PIC16L (Com	<b>V54A-02</b> <b>V54A-02I</b> mercial, Ir	ndustrial)	Standa Operat	ard Ope ting Ten	erating nperat	<b>g Cond</b> ure -	litions (unless otherwise specified) $0^{\circ}C \le TA \le +70^{\circ}C$ for commercial $-20^{\circ}C \le TA \le +85^{\circ}C$ for industrial
Param No.	Symbol	Characteristic	Min	Тур†	Max	Units	Conditions
D001	Vdd	Supply Voltage RC and XT modes	2.0	_	3.8	v	
D002	Vdr	RAM Data Retention Voltage <sup>(1)</sup>	—	1.5*	—	V	Device in SLEEP mode
D003	VPOR	VDD Start Voltage to ensure Power-on Reset	—	Vss	—	V	See Section 5.1 for details on Power-on Reset
D004	SVDD	VDD Rise Rate to ensure Power-on Reset	0.05*	_	—	V/ms	See Section 5.1 for details on Power-on Reset
D010	IDD	<b>Supply Current<sup>(2)</sup></b> RC <sup>(3)</sup> and XT modes LP mode, Commercial LP mode, Industrial		0.5 11 14	 27 35	mA μA μA	Fosc = 2.0 MHz, VDD = 3.0V Fosc = 32 kHz, VDD = 2.5V WDT disabled Fosc = 32 kHz, VDD = 2.5V WDT disabled
D020	IPD	Power-down Current <sup>(2,4)</sup> Commercial Commercial Industrial Industrial		2.5 0.25 3.5 0.3	12 4.0 14 5.0	μΑ μΑ μΑ	VDD = 2.5V, WDT enabled VDD = 2.5V, WDT disabled VDD = 2.5V, WDT enabled VDD = 2.5V, WDT enabled

These parameters are characterized but not tested.

- † Data in the Typical ("Typ") column is based on characterization results at 25°C. This data is for design guidance only and is not tested.
- **Note 1:** This is the limit to which VDD can be lowered in SLEEP mode without losing RAM data.
  - 2: The supply current is mainly a function of the operating voltage and frequency. Other factors such as bus loading, oscillator type, bus rate, internal code execution pattern and temperature also have an impact on the current consumption.
    - a) The test conditions for all IDD measurements in active Operation mode are: OSC1 = external square wave, from rail-to-rail; all I/O pins tristated, pulled to VSS, T0CKI = VDD, MCLR = VDD; WDT enabled/ disabled as specified.
    - b) For standby current measurements, the conditions are the same, except that the device is in SLEEP mode. The power-down current in SLEEP mode does not depend on the oscillator type.
  - **3:** Does not include current through REXT. The current through the resistor can be estimated by the formula: IR = VDD/2REXT (mA) with REXT in kΩ.
  - 4: The oscillator start-up time can be as much as 8 seconds for XT and LP oscillator selection on wake-up from SLEEP mode or during initial power-up.

#### 17.1 DC Characteristics:PIC16C54C/C55A/C56A/C57C/C58B-04, 20 (Commercial, Industrial) PIC16LC54C/LC55A/LC56A/LC57C/LC58B-04 (Commercial, Industrial) PIC16CR54C/CR56A/CR57C/CR58B-04, 20 (Commercial, Industrial) PIC16LCR54C/LCR56A/LCR57C/LCR58B-04 (Commercial, Industrial)

PIC16LC5X PIC16LCR5X (Commercial, Industrial) PIC16C5X PIC16CR5X (Commercial, Industrial)									
Param No.	Symbol	Characteristic/Device	Min	Тур†	Max	Units	Conditions		
	Vdd	Supply Voltage							
D001		PIC16LC5X	2.5 2.7 2.5		5.5 5.5 5.5	V V V	$\begin{array}{l} -40^{\circ}C \leq TA \leq +\ 85^{\circ}C,\ 16LCR5X \\ -40^{\circ}C \leq TA \leq 0^{\circ}C,\ 16LC5X \\ 0^{\circ}C \leq TA \leq +\ 85^{\circ}C \ 16LC5X \end{array}$		
D001A		PIC16C5X	3.0 4.5		5.5 5.5	V V	RC, XT, LP and HS mode from 0 - 10 MHz from 10 - 20 MHz		
D002	Vdr	RAM Data Retention Volt- age <sup>(1)</sup>	—	1.5*	-	V	Device in SLEEP mode		
D003	VPOR	VDD Start Voltage to ensure Power-on Reset	—	Vss	—	V	See Section 5.1 for details on Power-on Reset		
D004	SVDD	VDD Rise Rate to ensure Power-on Reset	0.05*	—	_	V/ms	See Section 5.1 for details on Power-on Reset		

Legend: Rows with standard voltage device data only are shaded for improved readability.

\* These parameters are characterized but not tested.

- † Data in "Typ" column is at 5V, 25°C, unless otherwise stated. These parameters are for design guidance only, and are not tested.
- Note 1: This is the limit to which VDD can be lowered in SLEEP mode without losing RAM data.
  - 2: The supply current is mainly a function of the operating voltage and frequency. Other factors such as bus loading, oscillator type, bus rate, internal code execution pattern and temperature also have an impact on the current consumption.
    - a) The test conditions for all IDD measurements in active Operation mode are: OSC1 = external square wave, from rail-to-rail; all I/O pins tristated, pulled to Vss, T0CKI = VDD, MCLR = VDD; WDT enabled/disabled as specified.
    - b) For standby current measurements, the conditions are the same, except that the device is in SLEEP mode. The power-down current in SLEEP mode does not depend on the oscillator type.
  - **3:** Does not include current through REXT. The current through the resistor can be estimated by the formula: IR = VDD/2REXT (mA) with REXT in k $\Omega$ .

# 18.0 DEVICE CHARACTERIZATION - PIC16LC54A

The graphs and tables provided following this note are a statistical summary based on a limited number of samples and are provided for informational purposes only. The performance characteristics listed herein are not tested or guaranteed. In some graphs or tables, the data presented may be outside the specified operating range (e.g., outside specified power supply range) and therefore outside the warranted range.

"Typical" represents the mean of the distribution at 25°C. "Maximum" or "minimum" represents (mean +  $3\sigma$ ) or (mean -  $3\sigma$ ) respectively, where  $\sigma$  is a standard deviation, over the whole temperature range.



FIGURE 18-1: TYPICAL RC OSCILLATOR FREQUENCY vs. TEMPERATURE

#### TABLE 18-1: RC OSCILLATOR FREQUENCIES

Сехт	Rext	Average Fosc @ 5V, 25°C			
20 pF	3.3K	5 MHz	± 27%		
	5K	3.8 MHz	± 21%		
	10K	2.2 MHz	± 21%		
	100K	262 kHz	± 31%		
100 pF	3.3K	1.63 MHz	± 13%		
	5K	1.2 MHz	± 13%		
	10K	684 kHz	± 18%		
	100K	71 kHz	± 25%		
300 pF	3.3K	660 kHz	± 10%		
	5.0K	484 kHz	± 14%		
	10K	267 kHz	± 15%		
	100K	29 kHz	± 19%		

The frequencies are measured on DIP packages.

The percentage variation indicated here is part-to-part variation due to normal process distribution. The variation indicated is  $\pm 3$  standard deviation from average value for VDD = 5V.

# PIC16C5X

FIGURE 19-1: PIC16C54C/C55A/C56A/C57C/C58B-40 VOLTAGE-FREQUENCY GRAPH,  $0^{\circ}C \le T_A \le +70^{\circ}C$ 





- **2:** The maximum rated speed of the part limits the permissible combinations of voltage and frequency. Please reference the Product Identification System section for the maximum rated speed of the parts.
- **3:** Operation between 20 to 40 MHz requires the following:
  - VDD between 4.5V. and 5.5V
  - OSC1 externally driven
  - OSC2 not connected
  - HS mode
  - Commercial temperatures

Devices qualified for 40 MHz operation have -40 designation (ex: PIC16C54C-40/P).

4: For operation between DC and 20 MHz, see Section 17.1.

# **ON-LINE SUPPORT**

Microchip provides on-line support on the Microchip World Wide Web (WWW) site.

The web site is used by Microchip as a means to make files and information easily available to customers. To view the site, the user must have access to the Internet and a web browser, such as Netscape or Microsoft Explorer. Files are also available for FTP download from our FTP site.

#### Connecting to the Microchip Internet Web Site

The Microchip web site is available by using your favorite Internet browser to attach to:

#### www.microchip.com

The file transfer site is available by using an FTP service to connect to:

#### ftp://ftp.microchip.com

The web site and file transfer site provide a variety of services. Users may download files for the latest Development Tools, Data Sheets, Application Notes, User's Guides, Articles and Sample Programs. A variety of Microchip specific business information is also available, including listings of Microchip sales offices, distributors and factory representatives. Other data available for consideration is:

- Latest Microchip Press Releases
- Technical Support Section with Frequently Asked
  Questions
- Design Tips
- Device Errata
- Job Postings
- Microchip Consultant Program Member Listing
- Links to other useful web sites related to Microchip Products
- Conferences for products, Development Systems, technical information and more
- Listing of seminars and events